

CCM02-MKI-ROHS

Ref./ PS-CCM02-MKI-1

Page 1 / 6

ISSUE 1 – Rev. B: SEPTEMBER 2008

Approvals:

Laurent Kubat
Engineering Manager

Guillaume Pinon
Project Manager

Daniel Pequegnot
Laboratory Manager

Jerome Smolinski
Product Manager

Jérome Brochot
Quality Director

Note

This specification, attached documents and attached drawings cannot be communicated to anybody without written agreement of C&K.



September 2008

CCM02-MKI-ROHS

Issue 1-rev.B

Ref./ PS-CCM02-MKI-1

Page 2 / 6

Revision record:

Revision	Date	Comments
Issue 1	May 2 nd , 2006	Creation
Issue 1 – Rev. A	August 8 th , 2007	Update:
		 Soldering process
		Solderability: temperature & spec reference
		(according to ECR 628)
		 Resistance to fluids : comment added
		(according to ECR 1186)
Issue 1 – Rev. B	September 4 th , 2008	Update:
		UL data suppressed
		(according to ECR 2324)
		 Reference of test specifications updated
		(according to ECR 2446)



September 2008

CCM02-MKI-ROHS

Issue 1-rev.B

Ref./ PS-CCM02-MKI-1

Page 3 / 6

SUMMARY

Preliminary /	versions c	overed by	this s	pecification
	TOI DIOILD C	0,0104		pecification

- 1. Description
- 2. Physical data
- 3. Using temperatures
- 4. Electrical data
- 5. Mechanical data
- 6. Additional data: storage and handling environment
- 7. Additional data: process environment
- 8. Additional data: operating environment
- 9. Additional data: Applicable norms
- 10. Qualification Plan



September 2008

CCM02-MKI-ROHS

Issue 1-rev.B

Ref./ PS-CCM02-MKI-1

Page 4 / 6

VERSIONS COVERED BY THIS SPECIFICATION

Reference	Drawing N°	Cts number	Switch
CCM02-1NO-3 RoHS	CU 030288Y0207	2 x 4 cts	NO (normally open) Dust sealed switch
CCM02-1NO-32 RoHS	CU 030288Y0209	2 x 4 cts	NO (normally open) Dust sealed switch
CCM02-2NO-32 RoHS	CU 030288Y0215	2 x 8 cts	NO (normally open) Dust sealed switch
CCM02-0NO-503 RoHS	CU 030288Y0503	2 x 3 cts	NO (normally open) Dust sealed switch



September 2008

CCM02-MKI-ROHS

Issue 1-rev.B

Ref./ PS-CCM02-MKI-1

Page 5 / 6

1 - Description





Product group: CCM02

Product Sub Family: Mk1

ROHS Compliance

Card type: Full-sized card

Contact type: Landing

Contact plating: Selective gold

Contacts number: see table p. 4

Terminal type: Thru-hole

Card end travel switch: see table

Generic specification (C&K):

Proc. essai 20

2 – <u>Physical data</u>	
Mass	6 g ± 2.0
Dimensions & lay out	According to drawing: see table page 4
3 – <u>Using temperatures</u>	
Operating temperatures	- 40 °C / + 85 °C
Storage temperatures	- 40 °C / + 85 °C
4 - Electrical data	
Voltage / ct	≤ 5 Vdc
Current / ct	≤ 10 mA
Contact resistance	$\leq 100 \text{ m}\Omega$
Voltage proof	≥ 750 Vrms
	Initial measurement $\geq 1000 \text{ M}\Omega \text{ (100 VDC)}$
Insulation resistance	After damp heat $\geq 1 \text{ M}\Omega$ recovery time : 4 hours
	After damp heat $\geq 200 \text{ M}\Omega$ recovery time : 24 hours

-	Max power	0.2 VA
-	Max voltage	30 Vdc

Min/Max current $50 \mu A \min / 10 mA \max$

Bounces $\leq 0.5 \text{ ms}$

Voltage proof ≥ 750Vrms between signal contact / switch contacts ≥ 250Vrms between open contacts of the switch

Insulation resistance Initial measurement $\geq 1000 \text{ M}\Omega \text{ (100 VDC)}$ After damp heat $\geq 1 \text{ M}\Omega$ recovery time : 4 hours

After damp heat $\geq 200~M\Omega$ recovery time : 24 hours between signal contact / switch contacts & between open contacts of the switch

Contact resistance $\leq 100 \text{ m}\Omega$

Card end travel switch Card end travel switch activates when the sliding sequence card is 1.0 mm from the card stop.

10 N max

5 – Mechanical data Card insertion force

Card withdrawal force 1N min / 10 N max Contact force (end travel 0.8 N max to activate the switch 1.8 N max for complete depression switch)

6 - Additional data: storage and handling environment

Designation: according to drawing Marking & Traceability Date code: year / week 30 samples per tray / 10 trays per box Packaging conditions Sea-air-land / World wide / High $\leq 5 \text{ m}$ Transport conditions 30°C / 85% HR According to H00-060

7 - Additional data: process environment

Soldering process	Single or double wave soldering process
Solder heat resistance	260°C / 5 sec. According to IEC 60068-44
Static load (transverse)	10N / 1 mn / 4 directions



September 2008

CCM02-MKI-ROHS

Issue 1-rev.B

Ref./ PS-CCM02-MKI-1

Page 6 / 6

Terminal robustness	1 bend / 45° / forward & back According to IEC 60068-2-21 test Ub method 1	
Contact retention in insert	2 N / 10sec./ displacement < 0.3 mm According to IEC 512-8 test 15a	
Solderability (wetting balance)	235°C According to IEC 60068-2-69	
Dust sealed test (only for switch)	Dust test / IP5x According to IEC 60529:1989/A1:1999	
Resistance to fluids	The product is not compatible with washing process.	
8 – Additional data : operating	environment	
Operating life	≥ 100 000 cycles	
Vibration	10-500 Hz / 50 m/s ² / 3 axis / 2 hours per axis No discontinuity > 1 μs According to IEC 60068-2-6.	
Mechanical shock	500 m/s² / ½ sinusoidal / 11 ms 3 shocks in the 2 directions of the 3 axis No discontinuity > 1 μs According to IEC 60068-2-27.	
Rapid change of temperature	100 cycles / - 40°C / + 85°C According to IEC60068-2-14, test Nb	
Climatic sequence	Dry heat: 85°C / 16 hours Damp heat: 1 cycle 24hours 55°C & 93% HR Cold: -40°C / 2 hours Damp heat: 1 cycle 24hours 55°C & 93% HR According to IEC 60068-2-61, test Z/ABDM	
Dry heat storage	85°C / 250 hours According to IEC 60068-2-2, test Bb.	
Damp heat storage	40°C / 93% HR / 10 days According to IEC 60068-2-78 test Cab	
Corrosion	96 hours / salt spray According to IEC 60068-2-11, test Ka.	
The environmental tests can be cumulative according to the qualification file		
9 - Additional data : applicable norms		
Legal norm (EHS)	ITT procedure	
Warranty period	1 year	
10- Qualification Plan		
According to PROC-20		